

T-33-05

**MOTOROLA
SEMICONDUCTOR
TECHNICAL DATA**

**The RF Line
UHF Power Transistor**

2

...designed as an NPN gold metallized transistor using diffused emitter ballast resistors for operation in Class A, AB and C.

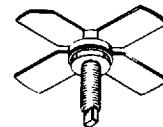
High gain reduces the complexity of the broadband stages and make the TPM405 ideal for 100-400 MHz applications.

A 100-400 MHz push-pull amplifier is described in the two last pages of this data sheet.

- 400 MHz
- 5 W — P_{out}
- High Gain — 16 dB Min @ $f = 400$ MHz
- Diffused Emitter Ballast Resistors for Ruggedness
- Gold Metallization for Reliability

TPM405

**5 W — 400 MHz
UHF POWER TRANSISTOR**



CASE 244C-01, STYLE 1
.280 SOE

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	24	Vdc
Collector-Base Voltage	V_{CBO}	45	Vdc
Emitter-Base Voltage	V_{EBO}	3.5	Vdc
Collector Current — Continuous	I_C	1.4	Adc
Operating Junction Temperature	T_J	200	°C
Storage Temperature Range	T_{stg}	-65 to +200	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case ($T_{case} = 70^\circ\text{C}$)	$R_{\theta JC}$	9.5	°C/W

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					

Collector-Base Breakdown Voltage ($I_C = 2$ mA, $I_E = 0$)	$V_{(BR)CBO}$	45	—	—	Vdc
Emitter-Base Breakdown Voltage ($I_E = 0.5$ mA, $I_C = 0$)	$V_{(BR)EBO}$	3.5	—	—	Vdc
Collector-Emitter Breakdown Voltage ($I_C = 40$ mA, $R_{BE} = 10 \Omega$)	$V_{(BR)CER}$	50	—	—	Vdc
Collector Cutoff Current ($V_{CB} = 28$ V, $I_E = 0$)	I_{CBO}	—	—	0.45	mAdc

ON CHARACTERISTICS

DC Current Gain ($I_C = 200$ mA, $V_{CE} = 5$ V)	β_{FE}	20	—	120	—
DYNAMIC CHARACTERISTICS					

Output Capacitance ($V_{CB} = 24$ V, $I_E = 0$, $f = 1$ MHz)	C_{ob}	—	—	7	pF
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(continued)

ELECTRICAL CHARACTERISTICS — continued

Characteristic	Symbol	Min	Typ	Max	Unit
FUNCTIONAL TESTS					
Common-Emitter Amplifier Power Gain — Class AB ($V_{CE} = 24$ V, $P_{out} = 5$ W, $f = 400$ MHz, $I_Q = 50$ mA)	GPE	16	—	—	dB
Collector Efficiency ($V_{CE} = 24$ V, $P_{out} = 5$ W, $f = 400$ MHz, $I_Q = 50$ mA)	η_C	50	—	—	%
Load Mismatch ($V_{CE} = 24$ V, $P_{out} = 3$ W, $f = 400$ MHz, $I_Q = 50$ mA, Load VSWR = $\infty:1$, All Phase Angles)	ψ	No Degradation in Output Power			
Saturated Output Power ($V_{CE} = 24$ V, $f = 400$ MHz, $I_Q = 50$ mA)	P_{sat}	7	—	—	W

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CLASS A - $V_{CE} = 20$ V - $I_C = 440$ mA - Small Signal

POLAR S-PARAMETERS IN 50 OHM SYSTEM								
F	S 11		S 21		S 12		S 22	
	MHz	Magn	Angl°	Magn	Angl°	Magn	Angl°	Magn
100 MHz	0.871	190	6.130	108	0.028	17	0.537	205
200 MHz	0.902	182	4.9	90	03	18	0.562	191
300 MHz	0.907	178	3.35	80	0.033	20	0.562	189
400 MHz	0.902	175	2.66	72	0.035	22	0.562	188
500 MHz	0.905	175	2.21	71	0.034	30	0.540	192

Large Signal Impedances

Class AB
 $P_{out} = 5$ W $I_Q = 50$ mA
 $V_{CE} = 20$ V $f_o = 400$ MHz

Z_{in}	Z_{OL^*}
(1.5 — J 1) ohm	(15.5 — J 21.4) ohm

 Z_{OL^*} = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency

MOTOROLA RF DEVICE DATA

PUSH-PULL PERFORMANCE

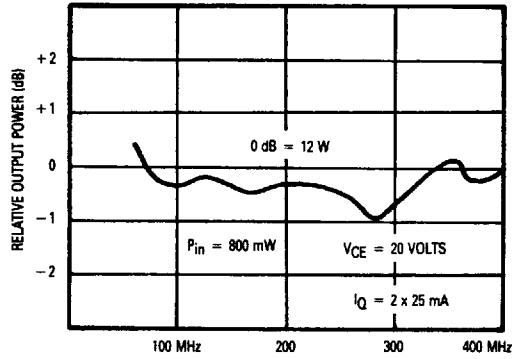


Figure 1. Output Power versus Frequency

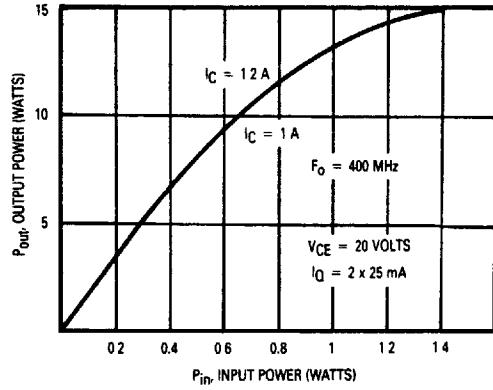


Figure 2. Output Power versus Input Power

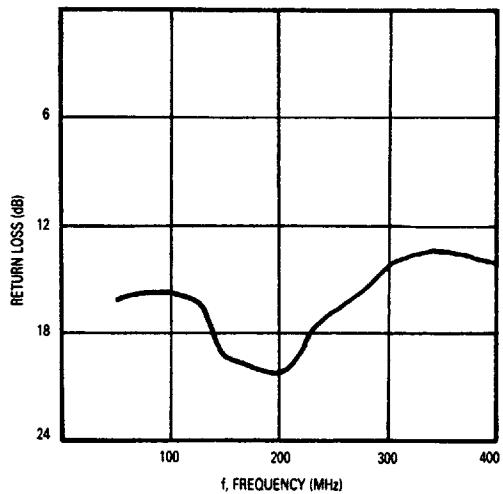
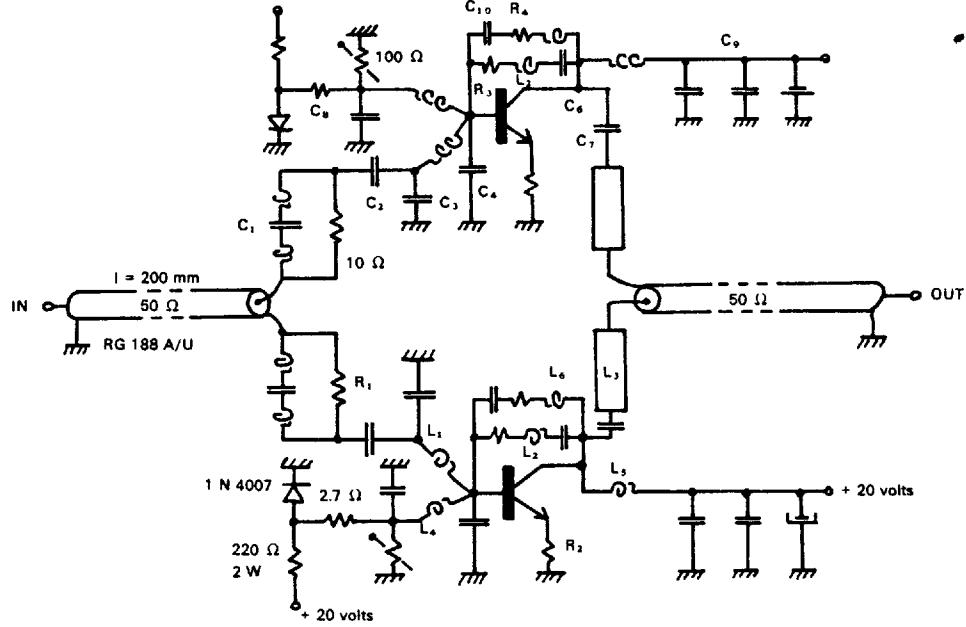


Figure 3. Input Return Loss

MOTOROLA RF DEVICE DATA

2-1270



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L1 — 1/2 turn 5 mm 5/10 mm
L2 — 6 turns Ø 3 mm 5/10 mm
L3 — 25 Ω line 2% λg at 400 MHz
L4 — Molded coil 0.47 μH
L5 — Molded coil 4.7 μH
L6 — 17 turns Ø 3 mm 5/10 mm

C1 — 27 pF C 300 RTC with 12 mm leads
C2, C7 — 10 nF chip
C3 — 27 pF ATC 100 A
C4 — 2 x 1.3 pF ATC 100 A
C6, C10 — 10 nF RTC C 331
C8, C9 — 1 nF + 10 nF + 0.1 μF + 10 μF decoupling

R1 — 10 Ω 1/4 W carbon
R2 — 4 x 1 Ω 1/4 W carbon
R3, R4 — 300 Ω 1/4 W carbon

Figure 4. Push-Pull Amplifier 100-400 MHz